

Form PTO-1449		Docket No: H 3497 PCT/US		International Application No: PCT/EP99/08645			
INFORMATION DISCLOSURE CITATION		Applicant: Klein et al.					
		International Filing Date: November 10, 1999		Group:			
US PATENT DOCUMENTS							
Examiner Initial*		Document Number	Date	Name	Class Sub-class Filing Date if Approp.		
<i>KIM</i>	AA	5,852,063	12/22/98	S. Meinhardt	521 83		
FOREIGN PATENT DOCUMENTS							
Examiner Initial *		Document Number	Date	Country	Class Sub-Class	English Translation	
						Yes	No
<i>KIM</i>	AB	41 34 550	5/4/95	Germany (US5852063)			X
<i>KIM</i>	AC	195 43 886	5/28/97	Germany			X
<i>KIM</i>	AD	76/139114	1/12/76	Japan			X
OTHER DOCUMENTS							
<i>KIM</i>	AE	Wirsching et al., <i>Fuellstoffe aus REA-Gips</i> , ZGK INTERNATIONAL, No. 5, (Vol. 48), pp. 241-256, (Bauverlag GmbH), 1995					
	AF	Mark et al., <i>Encyclopedia of Polymer Science and Technology</i> , 2nd. Edition, Vol.17, pp. 406-409, John Wiley, New York, 1989					
	AG	<i>Roempp Chemie-Lexikon</i> , 10th Edition, Vol. 2, pp. 1010-1011, Thieme-Verlag, 1990					
	AH	<i>Ullmann's Encyclopedia of Industrial Chemistry</i> , 5th Edition, Vol. A21, "Plastics, Properties and Testing to Polyvinyl Compounds", pp. v-vii, VCH, Weinheim, Germany, 1987					
	AI	<i>Ullmann's Encyclopedia of Industrial Chemistry</i> , 5th Edition, Vol A22, "Poly(Vinyl Esters) to Reduction", pp. 1-15, VCH, New York, 1993					
	AJ	<i>Handbook of Additives</i> , 3rd Edition, pp. 381-399, Chapman and Hall, 1990					
	AK	Lesko et al., <i>Emulsion Polymerization and Emulsion Polymers</i> , Chapter 18, "Acrylic and Styrene-Acrylic Polymers", pp. 619-655, John Wiley, New York, 1997					
<i>KIM</i>	AL	Blackley, D., <i>Emulsion Polymerization and Emulsion Polymers</i> , Chapter 15, "Diene-based Synthetic Rubbers", pp. 521-561, John Wiley, New York, 1997					
Examiner: <i>Katayna Myroslawski</i>		Date Considered: <i>Oct 21, 2002</i>					

Examiner: Initial if reference considered, whether or not citation is in conformance with MPEP 609; draw line through citation if not in conformance and not considered. Include copy of this form with next communication with applicant.